

SMD General Purpose Bridge Rectifier Diode



SMD Diodes Specialist

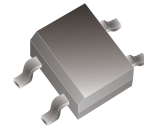
B05S-HF Thru B10S-HF

Reverse Voltage: 50 to 1000 Volts

Forward Current: 0.8 A

RoHS Device

Halogen Free

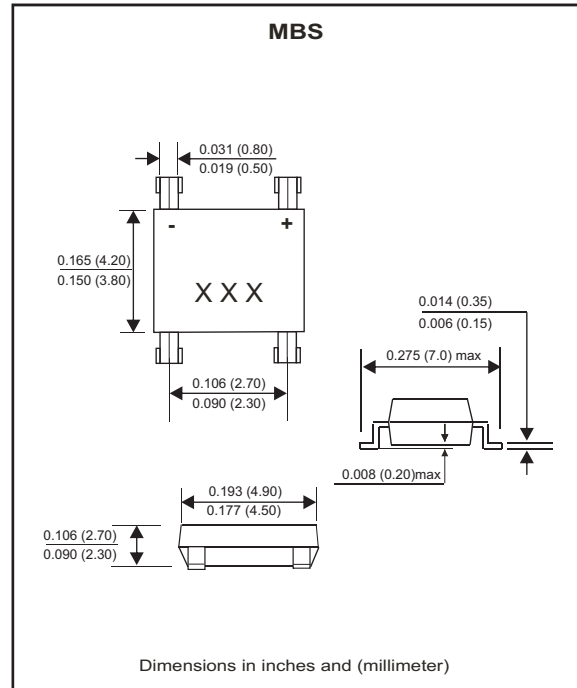


Features

- Rating to 1000V PRV.
- Ideal for printed circuit board.
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product.
- Pb free product.

Mechanical data

- Polarity: Symbol molded on body.
- Weight: 0.0044 ounces, 0.125grams.
- Mounting position: Any.



Maximum Rating And Electrical Characteristics

Rating at $T_A=25^{\circ}C$, unless otherwise noted.
 Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Parameter	Symbol	B05S-HF	B1S-HF	B2S-HF	B4S-HF	B6S-HF	B8S-HF	B10S-HF	Unit
	Marking	B05S	B1S	B2S	B4S	B6S	B8S	B10S	
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (Note 1) @ $T_A=40^{\circ}C$	$I_{(AV)}$	0.8							A
Peak Forward Surge Current, 8.3ms single half sine-wave, superimposed on rated load (JEDEC Method)	I_{FSM}	30							A
Maximum Forward Voltage at 0.8A DC	V_F	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage @ $T_J=25^{\circ}C$ @ $T_J=125^{\circ}C$	I_R	5.0 500							μA
Typical Junction Capacitance per element (Note 2)	C_J	15							pF
Typical Thermal Resistance (Note 3)	$R_{\theta JC}$	75							$^{\circ}C/W$
Operating Temperature Range	T_J	-55 to +150							$^{\circ}C$
Storage Temperature Range	T_{STG}	-55 to +150							$^{\circ}C$

Notes: 1. Mounted on P.C. Board.
 2. Measured at 1MHz and applied reverse voltage of 4V DC.
 3. Thermal resistance: Junction to case.

SMD General Purpose Bridge Rectifier Diode



SMD Diodes Specialist

RATING AND CHARACTERISTIC CURVES (B05S-HF Thru. B10S-HF)

Fig.1-Forward Current Derating Curve

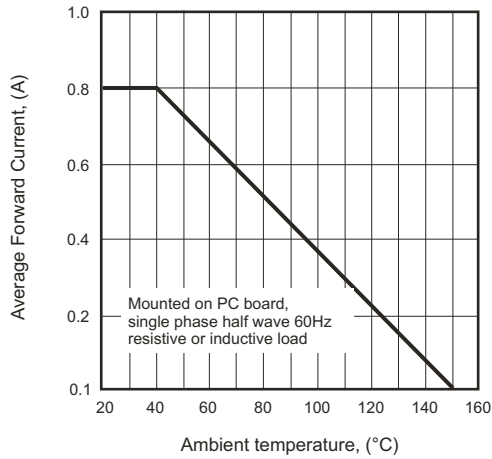


Fig.2-Maximum Non-Repetitive Surge Current

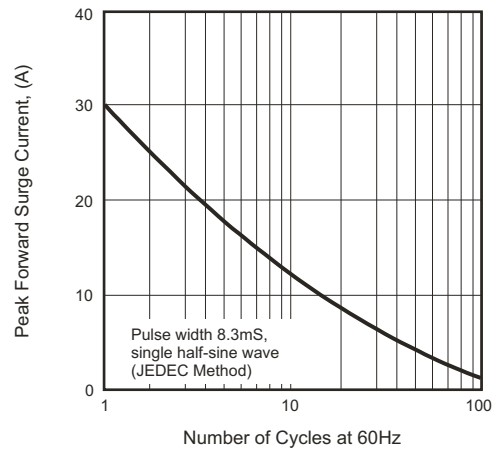


Fig.3-Typical Reverse Characteristics

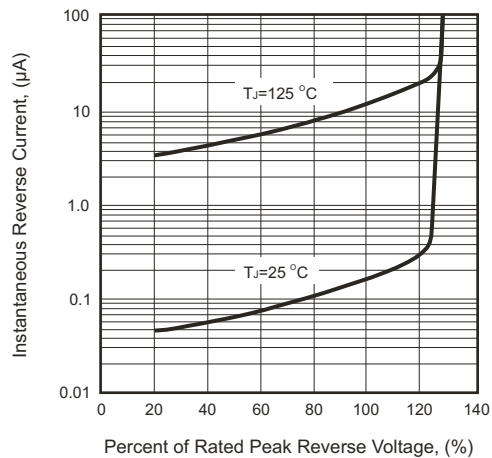


Fig.4-Typical Forward Characteristics

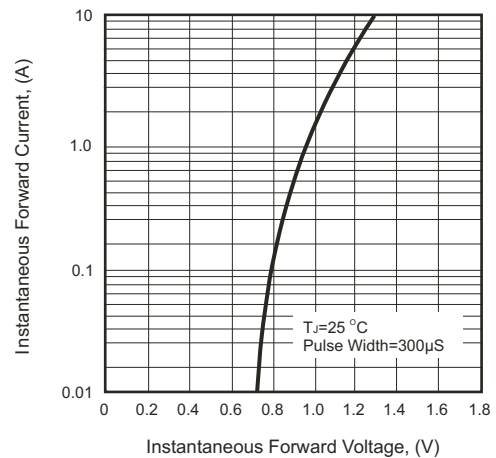
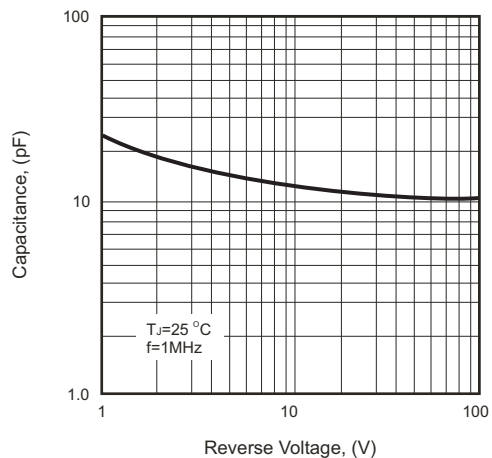
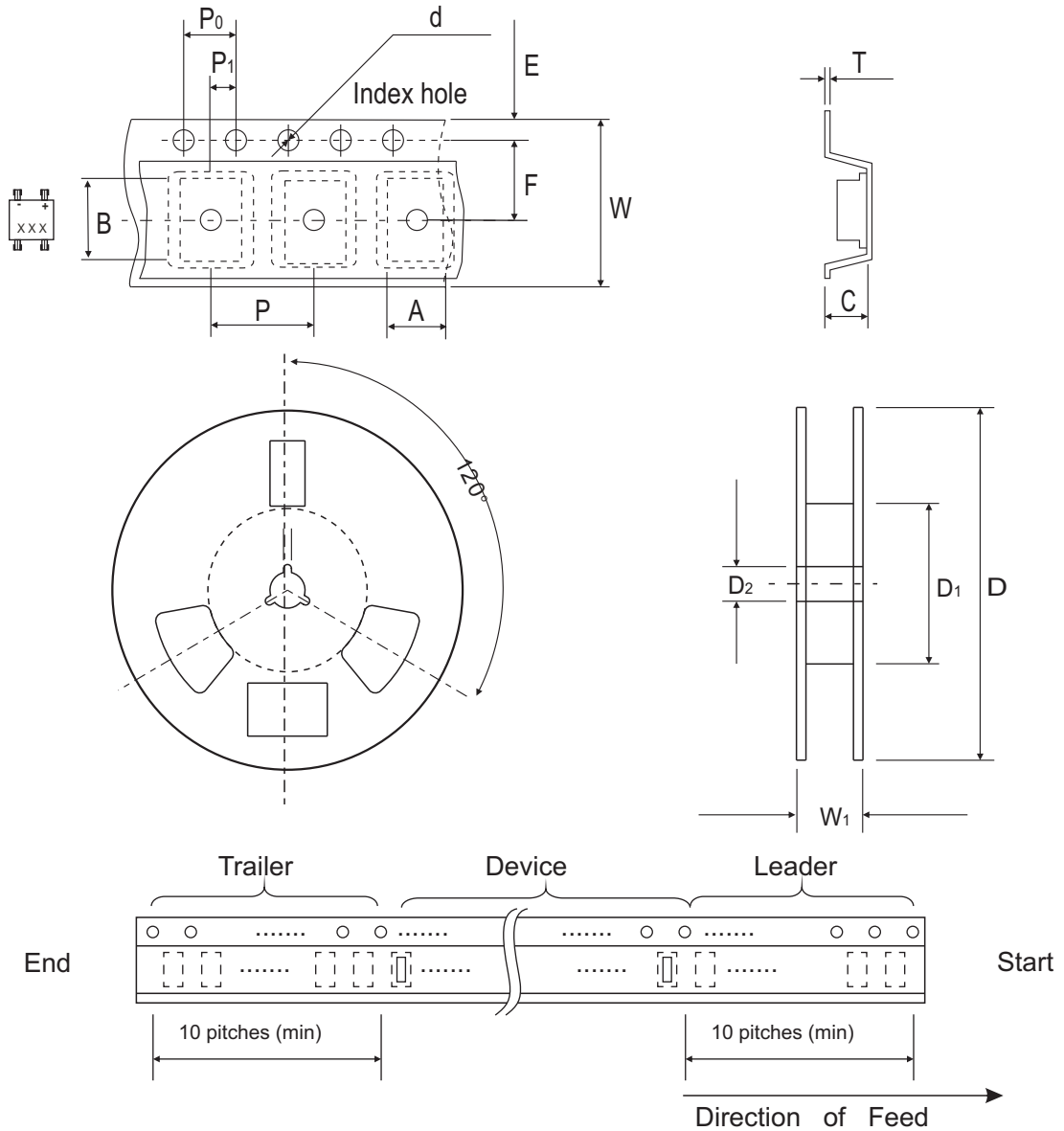


Fig.5-Typical Junction Capacitance



Reel Taping Specification

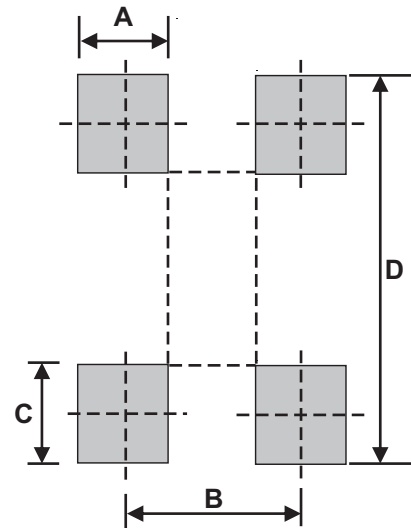


MBS	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	4.90 ± 0.10	7.24 ± 0.10	3.33 ± 0.10	1.55 ± 0.05	330	50.0 MIN.	13.0 ± 0.20
	(inch)	0.193 ± 0.004	0.285 ± 0.004	0.131 ± 0.004	0.061 ± 0.002	13	1.969 MIN.	0.512 ± 0.008

MBS	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	1.75 ± 0.10	5.50 ± 0.05	8.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	0.30	12.00 ± 0.30	12.00~14.40
	(inch)	0.069 ± 0.004	0.217 ± 0.002	0.315 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	0.012	0.472 ± 0.012	0.472~0.657

Suggested PAD Layout

SIZE	MBS	
	(mm)	(inch)
A	0.82MIN	0.032MIN
B	2.55REF	0.100REF
C	0.92MIN	0.036MIN
D	7.00MAX	0.276MAX



Standard Package

Case Type	Qty per Reel	Reel Size
	(Pcs)	(inch)
MBS	3000	13